

# Technical Datasheet

## DAC-QSFP28-4SFP25G-1.5M-AT

Universally Coded MSA 100Gb/s QSFP28 to 4SFP28

Direct Attach Cable Copper, Passive, 1.5m

### FEATURES

- Compatible with IEEE 802.3bj, IEEE 802.3by and InfiniBand EDR
- Supports aggregate data rates of 100Gbp/s
- Optimized construction to minimize insertion loss and cross talk
- Backward compatible with existing QSFP+ connectors and cages
- Pull-to-release slide latch design
- 26AWG through 30AWG cable
- Straight and break out assembly configurations
- Customized cable braid termination limits EMI radiation
- Customizable EEPROM mapping for cable signature
- RoHS compliant

### APPLICATIONS

- Switches, servers and routers
- Data Center networks

### STORAGE AREA NETWORKS

- High performance computing
- Telecommunication and wireless infrastructure
- Medical diagnostics and networking
- Test and measurement equipment

### INDUSTRIAL STANDARDS

- 100G Ethernet (IEEE 802.3bj)
- 25G Ethernet (IEEE 802.3by)
- InfiniBand EDR
- SFF-8665 QSFP+ 28G 4X Pluggable Transceiver Solution (QSFP28)
- SFF-8402 SFP+ 1X 28Gb/s Pluggable Transceiver Solution (SFP28)

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## DESCRIPTION

ATGBICS Universally Coded MSA QSFP28 passive copper cable assembly feature eight differential copper pairs, providing four data transmission channels at speeds up to 28Gbps per channel, and meets 100G Ethernet, 25G Ethernet and InfiniBand Enhanced Data Rate (EDR) requirements. Available in a broad range of wire gages-from 26AWG through 30AWG-this 100G copper cable assembly features low insertion loss and low cross talk.

Designed for applications in the data center, networking and telecommunications markets that require a high speed, reliable cable assembly, this next generation product shares the same mating interface with QSFP+ form factor, making it backward compatible with existing QSFP ports. QSFP28 can be used with current 10G and 14G applications with substantial signal integrity margin.

## High Speed Characteristics

Parameter	Symbol	Min	Typical	Max	Unit	Note
<b>Differential Impedance</b>	TDR	90	100	110	Ω	
<b>Insertion loss</b>	SDD21	-22.48			dB	At 12.8906 GHz
<b>Differential Return Loss</b>	SDD11			See 1	dB	At 0.05 to 4.1 GHz
	SDD22			See 2	dB	At 4.1 to 19 GHz
<b>Common-mode to common-mode output return loss</b>	SCC11 SCC22			-2	dB	At 0.2 to 19 GHz
<b>Differential to common mode return loss</b>	SCD11			See 3	dB	At 0.01 to 12.89 GHz
	SCD22			See 4		At 12.89 to 19 GHz
<b>Differential to common Mode Conversion Loss</b>	SCD21-IL			-10	dB	At 0.01 to 12.89 GHz
				See 5		At 12.89 to 15.7 GHz
				-6.3		At 15.7 to 19 GHz

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## Notes:

1. Reflection Coefficient given by equation  $SDD11(dB) < -16.5 + 2 \times \text{SQRT}(f)$ , with f in GHz
2. Reflection Coefficient given by equation  $SDD11(dB) < -10.66 + 14 \times \log_{10}(f/5.5)$ , with f in GHz
3. Reflection Coefficient given by equation  $SCD11(dB) < -22 + (20/25.78) * f$ , with f in GHz
4. Reflection Coefficient given by equation  $SCD11(dB) < -15 + (6/25.78) * f$ , with f in GHz
5. Reflection Coefficient given by equation  $SCD21(dB) < -27 + (29/22) * f$ , with f in GHz

## QSFP28 Pin Function Definition

Pin	Logic	Symbol	Description
1		GND	Ground
2	CML-I	Tx2n	Transmitter Inverted Data Input
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input
4		GND	Ground
5	CML-I	Tx4n	Transmitter Inverted Data Input
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input
7		GND	Ground
8	LVTTL-I	ModSelL	Module Select
9	LVTTL-I	ResetL	Module Reset
10		Vcc Rx	+3.3V Power Supply Receiver
11	LVC MOS-	SCL	2-wire serial interface clock
	I/O		
12	LVC MOS-	SDA	2-wire serial interface data
	I/O		
13		GND	Ground
14	CML-O	Rx3p	Receiver Non-Inverted Data Output
15	CML-O	Rx3n	Receiver Inverted Data Output
16		GND	Ground
17	CML-O	Rx1p	Receiver Non-Inverted Data Output
18	CML-O	Rx1n	Receiver Inverted Data Output
19		GND	Ground
20		GND	Ground
21	CML-O	Rx2n	Receiver Inverted Data Output
22	CML-O	Rx2p	Receiver Non-Inverted Data Output
23		GND	Ground
24	CML-O	Rx4n	Receiver Inverted Data Output
25	CML-O	Rx4p	Receiver Non-Inverted Data Output
26		GND	Ground
27	LVTTL-O	ModPrsL	Module Present
28	LVTTL-O	IntL	Interrupt

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29		Vcc Tx	+3.3V Power supply transmitter
30		Vcc1	+3.3V Power supply
31	LVTTL-I	LPMode	Low Power Mode
32		GND	Ground
33	CML-I	Tx3p	Transmitter Non-Inverted Data Input
34	CML-I	Tx3n	Transmitter Inverted Data Input
35		GND	Ground
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input
37	CML-I	Tx1n	Transmitter Inverted Data Input
38		GND	Ground

## SFP28 Pin Function Definition

Pin	Logic	Symbol	Description
1		GND	Ground
2	CML-I	Tx2n	Transmitter Inverted Data Input
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input
4		GND	Ground
5	CML-I	Tx4n	Transmitter Inverted Data Input
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input
7		GND	Ground
8	LVTTL-I	ModSelL	Module Select
9	LVTTL-I	ResetL	Module Reset
10		Vcc Rx	+3.3V Power Supply Receiver
11	LVC MOS-I/O	SCL	2-wire serial interface clock
12	LVC MOS-I/O	SDA	2-wire serial interface data
13		GND	Ground
14	CML-O	Rx3p	Receiver Non-Inverted Data Output
15	CML-O	Rx3n	Receiver Inverted Data Output
16		GND	Ground
17	CML-O	Rx1p	Receiver Non-Inverted Data Output
18	CML-O	Rx1n	Receiver Inverted Data Output
19		GND	Ground

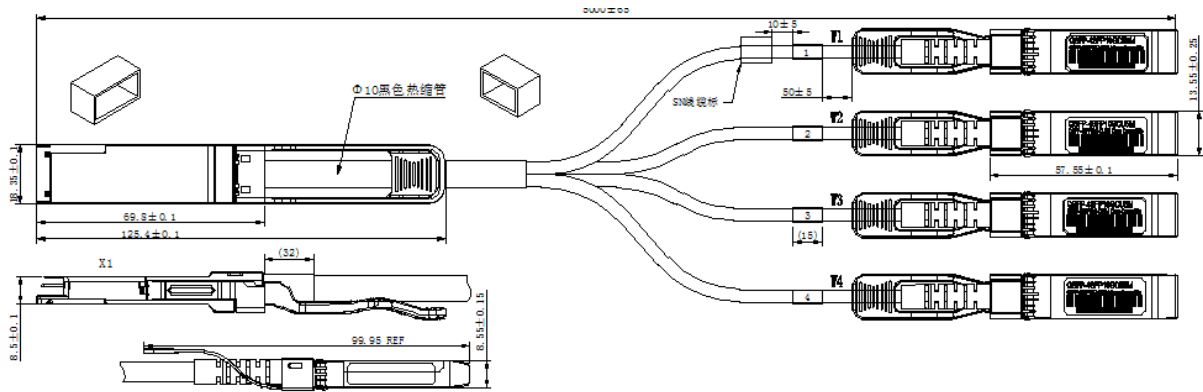
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<b>20</b>		GND	Ground
<b>21</b>	CML-O	Rx2n	Receiver Inverted Data Output
<b>22</b>	CML-O	Rx2p	Receiver Non-Inverted Data Output
<b>23</b>		GND	Ground
<b>24</b>	CML-O	Rx4n	Receiver Inverted Data Output
<b>25</b>	CML-O	Rx4p	Receiver Non-Inverted Data Output
<b>26</b>		GND	Ground
<b>27</b>	LVTTL-O	ModPrsL	Module Present
<b>28</b>	LVTTL-O	IntL	Interrupt
<b>29</b>		Vcc Tx	+3.3V Power supply transmitter
<b>30</b>		Vcc1	+3.3V Power supply
<b>31</b>	LVTTL-I	LPMode	Low Power Mode
<b>32</b>		GND	Ground
<b>33</b>	CML-I	Tx3p	Transmitter Non-Inverted Data Input
<b>34</b>	CML-I	Tx3n	Transmitter Inverted Data Input
<b>35</b>		GND	Ground
<b>36</b>	CML-I	Tx1p	Transmitter Non-Inverted Data Input
<b>37</b>	CML-I	Tx1n	Transmitter Inverted Data Input
<b>38</b>		GND	Ground

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## Mechanical Information

The connector is compatible with the SFF-8436 specification



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## AWG Information

Length (m)	Cable AWG
1	30
2	30
3	26/30
4	26
5	26

## General Product Characteristics

Q/4SFP+ DAC Specifications	
<b>Number of Lanes</b>	Tx & Rx
<b>Channel Data Rate</b>	10.3125 Gbps
<b>Operating Temperature</b>	0 to + 70°C
<b>Storage Temperature</b>	-40 to + 85°C
<b>Supply Voltage</b>	3.3 V nominal
<b>Electrical Interface</b>	38 pins edge connector (QSFP+) 20 pins edge connector (SFP+)
<b>Management Interface</b>	Serial, I2C

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## Regulatory Compliance

Feature	Test Method	Performance
<b>Electrostatic Discharge (ESD) to the Electrical Pins</b>	MIL-STD-883C Method 3015.7	Class 1 (>2000 Volts)
<b>Electromagnetic Interference (EMI)</b>	FCC Class B	Compliant with Standards
	CENELEC EN55022 Class B	
	CISPR22 ITE Class B	
<b>RF Immunity (RFI)</b>	IEC61000-4-3	Typically Show no Measurable Effect from a 10V/m Field Swept from 80 to 1000MHz
<b>RoHS Compliance</b>	RoHS Directive 2011/65/EU and it's Amendment Directives (EU) 2015/863	RoHS (EU) 2015/863 compliant
<b>REACH Compliance</b>	REACH Regulation (EC) No 1907/2006	REACH (EC) No 1907/2006 compliant